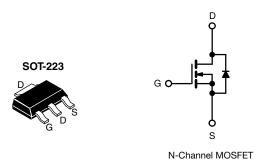


Vishay Siliconix

HALOGEN

FREE

Power MOSFET



Marking code: FD

PRODUCT SUMMA	RY	
V _{DS} (V)	250)
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	2.0
Q _g (Max.) (nC)	8.2	
Q _{gs} (nC)	1.8	
Q _{gd} (nC)	4.5	
Configuration	Sing	le

FEATURES

- Surface-mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION	
Package	SOT-223
Load (Dh) free and helegan free	SiHFL214TR-GE3 ^a
Lead (Pb)-free and halogen-free	IRFL214TRPbF-BE3 ^{a, b}
Lead (Pb)-free	IRFL214TRPbF ^a

Notes

- a. See device orientation
- b. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	250	V	
Gate-source voltage			V_{GS}	± 20	7 v
Continuous dusin suurent	V at 10 V	T _C = 25 °C		0.79	
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	Ι _D	0.50	Α
Pulsed drain current ^a		I _{DM}	6.3		
Linear derating factor				0.025	W//9C
ear derating factor (PCB mount) ^e			0.017	W/°C	
Single pulse avalanche energy ^b		E _{AS}	50	mJ	
Avalanche current ^a		I _{AR}	0.79	Α	
Repetitive avalanche energy ^a		E _{AR}	0.31	mJ	
Maximum power dissipation	T _C =	25 °C	В	3.1	W
Maximum power dissipation (PCB mount) e	T _A =	25 °C	P_D	2.0	
Peak diode recovery dv/dt ^c		dV/dt	4.8	V/ns	
Operating junction and storage temperature range		T _J , T _{stg} -55 to +150		- °C	
Soldering recommendations (peak temperature) d	For	10 s		300	7

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 128 mH, R_g = 25 Ω , I_{AS} = 0.79 A (see fig. 12)
- c. $I_{SD} \le 2.7$ A, $dI/dt \le 65$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C
- d. 1.6 mm from case
- e. When mounted on 1" square PCB (FR-4 or G-10 material)

S21-0322-Rev. F, 05-Apr-2021 **1** Document Number: 91194



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THERMAL RESISTANCE RAT	INGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	250	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.39	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
7	I _{DSS}	V _{DS} =	V _{DS} = 250 V, V _{GS} = 0 V		-	25	μA
Zero gate voltage drain current		V _{DS} = 200 V	V _{DS} = 200 V, V _{GS} = 0 V, T _J = 125 °C		-	250	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 0.47 A ^b	-	-	2.0	Ω
Forward transconductance	9 _{fs}			S			
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	140	-	
Output capacitance	C _{oss}		$V_{DS} = 25 \text{ V},$	-	42	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	9.6	-	
Total gate charge	Qg			-	-	8.2	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$	$I_D = 2.7 \text{ A}, V_{DS} = 200 \text{ V},$ see fig. 6 and 13 b	-		1.8	nC
Gate-drain charge	Q _{gd}		occ ng. o and ro	-		4.5	
Turn-on delay time	t _{d(on)}			-	7.0	-	
Rise time	t _r	V _{DD} = 125 V, I _D = 2.7 A, - 7.6 -		-	ns		
Turn-off delay time	t _{d(off)}	$R_{g} = 24 \Omega, R_{D} = 45 \Omega, \text{ see fig. } 10^{\text{ b}}$		-			
Fall time	t _f			-	7.0		
Internal drain inductance	L _D	Between lead		=	4.0	-	
Internal source inductance	L _S	6 mm (0.25") from package and center of die contact		-	nH		
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET sym	bol	-	-	0.79	
Pulsed diode forward current ^a	I _{SM}	integral revers p - n junction		-	-	6.3	Α
Body diode voltage	V_{SD}	T _J = 25 °C,	I _S = 0.79 A, V _{GS} = 0 V b	-	-	2.0	V
Body diode reverse recovery time	t _{rr}	T 05 %C !	0.7 4 -11/-14 - 4.00 4./ - 5	-	190	390	ns
Body diode reverse recovery charge	Q _{rr}	── T₁= 25 °C. I⊨ = 2.7 A. dl/dt = 100 A/us b		1.3	μC		
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	v L _s and	<u>LD)</u>

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

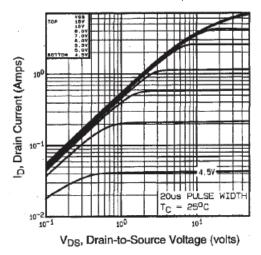


Fig. 1 - Typical Output Characteristics

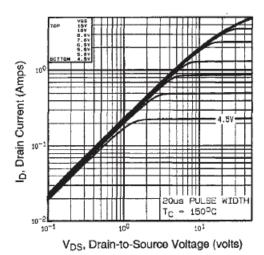


Fig. 2 - Typical Output Characteristics

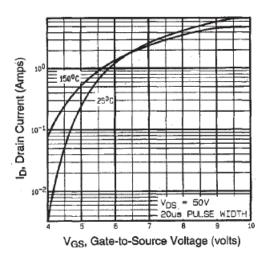


Fig. 3 - Typical Transfer Characteristics

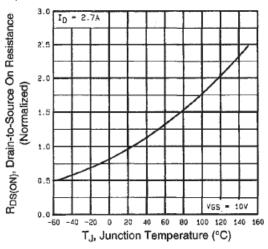


Fig. 4 - Normalized On-Resistance vs. Temperature

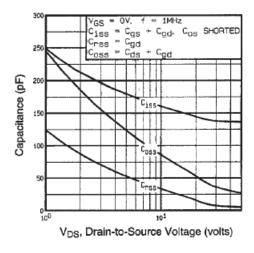


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

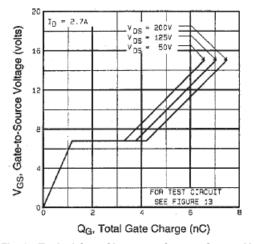


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



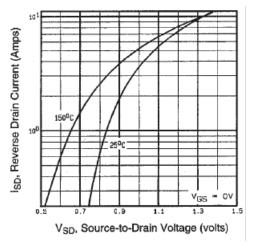


Fig. 7 - Typical Source-Drain Diode Forward Voltage

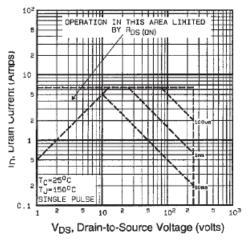


Fig. 8 - Maximum Safe Operating Area

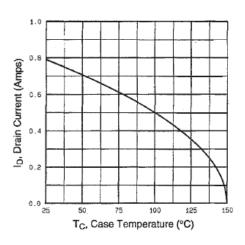


Fig. 9 - Maximum Drain Current vs. Case Temperature

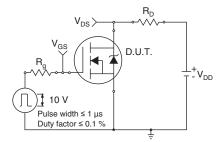


Fig. 10a - Switching Time Test Circuit

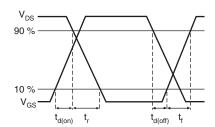


Fig. 10b - Switching Time Waveforms

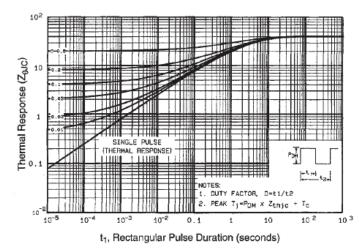


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



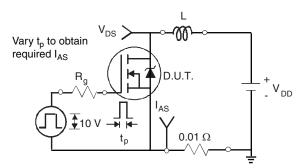


Fig. 12a - Unclamped Inductive Test Circuit

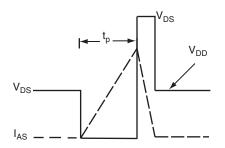


Fig. 12b - Unclamped Inductive Waveforms

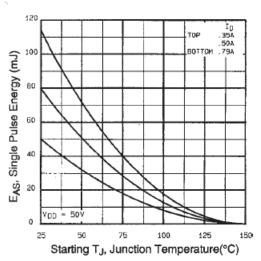


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

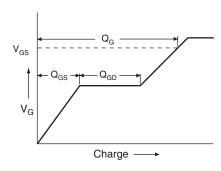


Fig. 13a - Basic Gate Charge Waveform

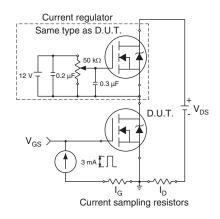
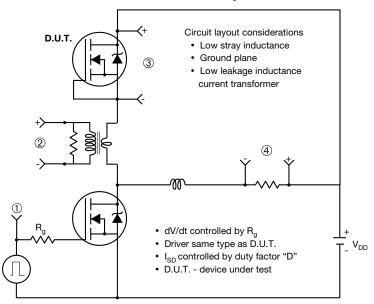


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



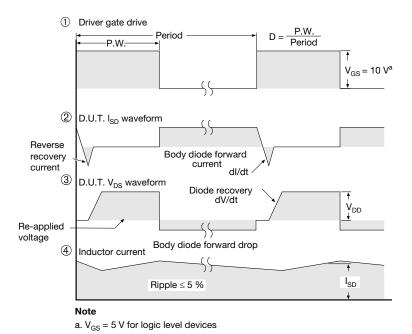


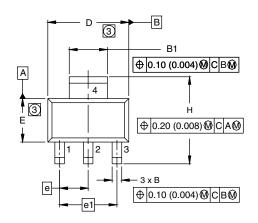
Fig.14 - For N-Channel

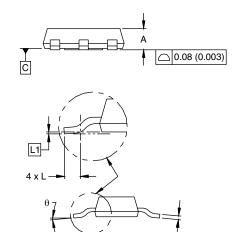
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Vishay Siliconix

SOT-223 (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905	BSC	
e1	4.60	O BSC	0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	=	
L1	0.061 BSC		0.0024	BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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